

16-Channel, 12-Bit Voltage-Output DAC with 14-Bit Increment Mode

AD5516*

FEATURES

High Integration: 16-Channel DAC in 12 mm \times 12 mm CSPBGA **14-Bit Resolution via Increment/Decrement Mode Guaranteed Monotonic Low Power, SPI®, QSPI™, MICROWIRE™, and DSP Compatible 3-Wire Serial Interface Output Impedance 0.5** Ω **Output Voltage Range 2.5 V (AD5516-1) 5 V (AD5516-2) 10 V (AD5516-3) Asynchronous Reset Facility (via RESET Pin) Asynchronous Power-Down Facility (via PD Pin) Daisy-Chain Mode Temperature Range: –40C to +85C**

GENERAL DESCRIPTION

The AD5516 is a 16-channel, 12-bit voltage-output DAC. The selected DAC register is written to via the 3-wire serial interface. DAC selection is accomplished via address bits A3–A0. 14-bit resolution can be achieved by fine adjustment in Increment/Decrement Mode (Mode 2). The serial interface operates at clock rates up to 20 MHz and is compatible with standard SPI, MICROWIRE, and DSP interface standards. The output voltage range is fixed at ± 2.5 V (AD5516-1), ± 5 V (AD5516-2), and ± 10 V (AD5516-3). Access to the feedback resistor in each channel is provided via the R_{FB} 0 to R_{FB} 15 pins.

The device is operated with $AV_{CC} = 5 V \pm 5\%, DV_{CC} = 2.7 V$ to 5.25 V, $V_{SS} = -4.75$ V to -12 V, and $V_{DD} = +4.75$ V to $+12$ V, and requires a stable 3 V reference on REF_IN.

PRODUCT HIGHLIGHTS

- 1. Sixteen 12-bit DACs in one package, guaranteed monotonic.
- 2. Available in a 74-lead CSPBGA package with a body size of 12 mm \times 12 mm.

APPLICATIONS Level Setting Instrumentation Automatic Test Equipment Optical Networks Industrial Control Systems Data Acquisition Low Cost I/O

FUNCTIONAL BLOCK DIAGRAM

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AD5516—SPECIFICATIONS $\frac{(V_{DD} = +4.75 \text{ V to } +13.2 \text{ V, } V_{SS} = -4.75 \text{ V to } -13.2 \text{ V; AV}_{CC} = 4.75 \text{ V to } 5.25 \text{ V; DV}_{CC} =$ All specifications T_{MIN} to T_{MAX} , unless otherwise noted.)

NOTES

¹ See Terminology section.
² A Version: Industrial temperature range –40°C to +85°C; typical at +25°C.

³ Guaranteed by design and characterization; not production tested.

 4 AD780 as reference for the AD5516.

 5 Output range is restricted from V_{SS} + 2 V to V_{DD} – 2 V. Output span varies with reference voltage and is functional down to 2 V. ⁶ Ensure that you do not exceed T_{J (MAX)}. See Absolute Maximum Ratings section.

⁷ With 5 kΩ resistive load, footroom required is as follows: AD5516–1, 2 V; AD5516–2, 2.5 V; AD5516–3, 3 V. ⁸ Outputs unloaded.

Specifications subject to change without notice.

$\bf AC\ CHARACTERISTICS$ $(V_{DD} = +4.75~V~to~+13.2~V,~V_{SS} = -4.75~V~to~-13.2~V;~AV_{CC} = 4.75~V~to~5.25~V;~DV_{CC} = 2.7~V~to~5.25~V;$ All specifications T_{MIN} to T_{MAX}, unless otherwise noted.)

NOTES

¹See Terminology section.

²Guaranteed by design and characterization; not production tested.

³A version: Industrial temperature range –40°C to +85°C.

⁴ Timed from the end of a write sequence and includes *BUSY* low time.

Specifications subject to change without notice.

TIMING CHARACTERISTICS $\begin{array}{c} (V_{DD} = +4.75 \text{ V to } +13.2 \text{ V, V}_{SS} = -4.75 \text{ V to } -13.2 \text{ V; AV}_{CC} = 4.75 \text{ V to } 5.25 \text{ V; DV}_{CC} = 2.7 \text{ V to } 5.25 \text{ V;} \end{array}$

NOTES

¹See Timing Diagrams in Figures 1 and 2.

²Guaranteed by design and characterization; not production tested.

³All input signals are specified with tr = tf = 5 ns (10% to 90% of DV_{CC}) and timed from a voltage level of (V_{IL} + V_{IH})/2.
⁴This is measured with the load circuit of Figure 3.

Specifications subject to change without notice.

TIMING DIAGRAMS

Figure 1. Serial Interface Timing Diagram

Figure 2. Daisy-Chaining Timing Diagram

Figure 3. Load Circuit for D_{OUT} Timing Specifications

ABSOLUTE MAXIMUM RATINGS1, 2

¹Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

²Transient currents of up to 100 mA will not cause SCR latch-up.

ORDERING GUIDE

CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD5516 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

PIN CONFIGURATION

74-LEAD CSPBGA BALL CONFIGURATION

NC = Not Internally Connected

PIN FUNCTION DESCRIPTIONS

PIN FUNCTION DESCRIPTIONS (continued)

NOTES

¹Internal pull-down device on this logic input. Therefore it can be left floating and will default to a logic low condition.

2 Internal pull-up device on this logic input. Therefore it can be left floating and will default to a logic high condition.

TERMINOLOGY

Integral Nonlinearity (INL)

This is a measure of the maximum deviation from a straight line passing through the endpoints of the DAC transfer function. It is expressed in LSBs.

Differential Nonlinearity (DNL)

Differential nonlinearity (DNL) is the difference between the measured change and the ideal 1 LSB change between any two adjacent codes. A specified DNL of –1 LSB maximum ensures monotonicity.

Bipolar Zero Error

Bipolar zero error is the deviation of the DAC output from the ideal midscale of 0 V. It is measured with 10...00 loaded to the DAC. It is expressed in LSBs.

Positive Full-Scale Error

This is the error in the DAC output voltage with all 1s loaded to the DAC. Ideally the DAC output voltage, with all 1s loaded to the DAC registers, should be $2.5 V - 1$ LSB (AD5516-1), $5 V - 1$ LSB $(AD5516-2)$, and $10 V - 1$ LSB $(AD5516-3)$. It is expressed in LSBs.

Negative Full-Scale Error

This is the error in the DAC output voltage with all 0s loaded to the DAC. Ideally the DAC output voltage, with all 0s loaded to the DAC registers, should be –2.5 V (AD5516-1), –5 V (AD5516-2), and –10 V (AD5516-3). It is expressed in LSBs.

Output Temperature Coefficient

This is a measure of the change in analog output with changes in temperature. It is expressed in ppm/°C of FSR.

DC Power Supply Rejection Ratio

DC power supply rejection ratio (PSRR) is a measure of the change in analog output for a change in supply voltage $(V_{DD}$ and $V_{SS})$. It is expressed in dB. V_{DD} and V_{SS} are varied $\pm 5\%$.

DC Crosstalk

This is the dc change in the output level of one DAC at midscale in response to a full-scale code change (all 0s to all 1s and vice versa) and output change of another DAC. It is expressed in LSB.

Output Settling Time

This is the time taken from when the last data bit is clocked into the DAC until the output has settled to within ± 0.5 LSB of its final value (see TPC 7).

Digital-to-Analog Glitch Impulse

This is the area of the glitch injected into the analog output when the code in the DAC register changes state. It is specified as the area of the glitch in nV-s when the digital code is changed by 1 LSB at the major carry transition (011...11 to 100...00 or 100...00 to 011...11).

Digital Crosstalk

This is the glitch impulse transferred to the output of one DAC at midscale while a full-scale code change (all 1s to all 0s and vice versa) is being written to another DAC. It is expressed in nV-s.

Analog Crosstalk

This is the area of the glitch transferred to the output (V_{OUT}) of one DAC due to a full-scale change in the output (V_{OUT}) of another DAC. The area of the glitch is expressed in nV-s.

Digital Feedthrough

This is a measure of the impulse injected into the analog outputs from the digital control inputs when the part is not being written to, i.e., SYNC is high. It is specified in nV-s and measured with a worst-case change on the digital input pins, e.g., from all 0s to all 1s and vice versa.

Output Noise Spectral Density

This is a measure of internally generated random noise. Random noise is characterized as a spectral density (voltage per root hertz). It is measured in $nV/(Hz)^{1/2}$.

AD5516–Typical Performance Characteristics

TPC 1. Typical DNL Plot

TPC 2. Typical INL Plot

TPC 3. Typical INL Error and DNL Error vs. Temperature

TPC 4. Bipolar Zero Error and Full-Scale Error vs. Temperature

TPC 5. V_{OUT} vs. Temperature

TPC 6. V_{OUT} Source and Sink **Capability**

TPC 7. AD5516–1 Full-Scale Settling Time

TPC 8. Exiting Power-Down to Full Scale

–0.029 $T_A = 25^\circ C$ REF **IN** = 3V **–0.030 NEW VALUE CALIBRATION TIME –0.031 OLD VALUE 2.5s/DIV** da bala b **–0.032 5V 0V BUSY –0.033**

TPC 9. AD5516–1 Major Code Transition Glitch Impulse

TPC 10. AD5516-1 V_{OUT} Repeatability; Programming the Same Code Multiple Times

TPC 11. Bipolar Error Distribution

TPC 12. Positive Full-Scale Error Distribution

 TPC 13. Negative Full-Scale Error Distribution

TPC 14. Accuracy vs. Increment Step

TPC 15. Accuracy vs. Increment Step, Using All 12 Mode 2 Bits

FUNCTIONAL DESCRIPTION

The AD5516 consists of sixteen 12-bit DACs in a single package. A single reference input pin (REF_IN) is used to provide a 3 V reference for all 16 DACs. To update a DAC's output voltage, the required DAC is addressed via the 3-wire serial interface. Once the serial write is complete, the selected DAC converts the code into an output voltage. The output amplifiers translate the DAC output range to give the appropriate voltage range (\pm 2.5 V, \pm 5 V, or \pm 10 V) at output pins V_{OUT}0 to V_{OUT}15.

The AD5516 uses a self-calibrating architecture to achieve 12-bit performance. The calibration routine servos to select the appropriate voltage level on an internal 14-bit resolution DAC. *BUSY* output goes low for the duration of the calibration and further writes to the AD5516 are ignored while *BUSY* is low. *BUSY* low time is typically 25 µs. Noise during the calibration (\overline{BUSY} low period) can result in the selection of a voltage within a ±0.25 LSB band around the normal selected voltage. See TPC 10.

It is essential to minimize noise on REFIN for optimal performance. The AD780's specified decoupling makes it the ideal reference to drive the AD5516.

Upon power-on, all DACs power up to a reset value (see the RESET section).

DIGITAL-TO-ANALOG SECTION

The architecture of each DAC channel consists of a resistor string DAC followed by an output buffer amplifier with offset and gain. The voltage at the REF_IN pin provides the reference voltage for all 16 DACs. The input coding to the DACs is offset binary; this results in ideal output voltages as follows:

AD5516-1:
$$
V_{OUT} = \frac{2 \times V_{REF_IN} \times 2.5 \times D}{3 \times 2^N} - \frac{V_{REF_IN} \times 2.5}{3}
$$

AD5516-2:
$$
V_{OUT} = \frac{4 \times V_{REF_IN} \times 2.5 \times D}{3 \times 2^N} - \frac{2 V_{REF_IN} \times 2.5}{3}
$$

AD5516-3:
$$
V_{OUT} = \frac{8 \times V_{REF_IN} \times 2.5 \times D}{3 \times 2^N} - \frac{4 V_{REF_IN} \times 2.5}{3}
$$

Where:

 $D =$ decimal equivalent of the binary code that is loaded to the DAC register, i.e., 0–4095

 $N = \text{DAC resolution} = 12$

Table I illustrates ideal analog output versus DAC code.

Table I. DAC Register Contents AD5516-1

| MSB | LSB | Analog Output, V _{OUT} |
|----------------|----------------|-----------------------------------|
| 1111 1111 1111 | | $V_{REF IN} \times 2.5/3 - 1$ LSB |
| | 1000 0000 0000 | 0V |
| | 0000 0000 0000 | $-V_{REF IN} \times 2.5/3$ |

MODES OF OPERATION

The AD5516 has two modes of operation.

Mode 1 (MODE bits = 00): The user programs a 12-bit dataword to one of 16 channels via the serial interface. This word is loaded into the addressed DAC register and is then converted into an analog output voltage. During conversion, the *BUSY* output is low and all SCLK pulses are ignored. At the end of a conversion *BUSY* goes high, indicating that the update of the addressed DAC is complete. It is recommended that SCLK is not pulsed while **BUSY** is low. Mode 1 conversion takes 25 µs typ.

Mode 2 (MODE bits = 01 or 10): Mode 2 operation allows the user to increment or decrement the DAC output in 0.25 LSB steps, resulting in a 14-bit monotonic DAC. The amount by which the DAC output is incremented or decremented is determined by Mode 2 bits DB11–DB0, e.g., for a 0.25 LSB increment/decrement DB11...DB0 = 0000 0000 0001, while for a 2.5 LSB increment/ decrement, DB11...DB0 = 0000 0000 1010. The MODE bits determine whether the DAC data is incremented (01) or decremented (10). The maximum amount that the user is allowed to increment or decrement the DAC output is 4095 steps of 0.25 LSB, i.e., DB11...DB0 = 1111 1111 1111. Mode 2 update takes approximately $1 \mu s$. The Mode 2 feature allows increased resolution, but overall increment/decrement accuracy varies with increment/decrement step as shown in TPC 14 and TPC 15.

Mode 2 is useful in applications where greater resolution is required, for example, in servo applications requiring fine-tune to 14-bit resolution.

Figure 4. Mode 1 Data Format

Figure 5. Mode 2 Data Format

The user must allow 200 ns (min) between two consecutive Mode 2 writes in Standalone Mode and 400 ns (min) between two consecutive Mode 2 writes in Daisy-Chain Mode. During a Mode 2 operation the *BUSY* signal remains high.

See Figures 4 and 5 for Mode 1 and Mode 2 data formats.

When MODE bits = 11, the device is in No Operation mode. This may be useful in daisy-chain applications where the user does not wish to change the settings of the DACs. Simply write 11 to the MODE bits and the following address and data bits will be ignored.

SERIAL INTERFACE

The AD5516 has a 3-wire interface that is compatible with SPI/QSPI/MICROWIRE, and DSP interface standards. Data is written to the device in 18-bit words. This 18-bit word consists of two mode bits, four address bits, and 12 data bits as shown in Figure 4.

The serial interface works with both a continuous and burst clock. The first falling edge of *SYNC* resets a counter that counts the number of serial clocks to ensure the correct number of bits is shifted in and out of the serial shift registers. In order for another serial transfer to take place, the counter must be reset by the falling edge of *SYNC*.

A3–A0

Four address bits $(A3 = MSB$ Address, $A0 = LSB$). These are used to address one of 16 DACs.

Table II. Selected DAC

DB11–DB0

These are used to write a 12-bit word into the addressed DAC register. Figures 1 and 2 show the timing diagram for a write cycle to the AD5516.

SYNC FUNCTION

In both Standalone and Daisy-Chain Modes, *SYNC* is an edgetriggered input that acts as a frame synchronization signal and chip enable. Data can only be transferred into the device while *SYNC* is low. To start the serial data transfer, *SYNC* should be taken low observing the minimum *SYNC* falling to SCLK falling edge setup time, t_3 .

Standalone Mode (DCEN = 0)

After *SYNC* goes low, serial data will be shifted into the device's input shift register on the falling edges of SCLK for 18 clock pulses. After the falling edge of the 18th SCLK pulse, data will automatically be transferred from the input shift register to the addressed DAC.

SYNC must be taken high and low again for further serial data transfer. *SYNC* may be taken high after the falling edge of the 18th SCLK pulse, observing the minimum SCLK falling edge to **SYNC** rising edge time, t_6 . If **SYNC** is taken high before the 18th falling edge of SCLK, the data transfer will be aborted and the addressed DAC will not be updated. See the timing diagram in Figure 1.

Daisy-Chain Mode (DCEN = 1)

In Daisy-Chain Mode, the internal gating on SCLK is disabled. The SCLK is continuously applied to the input shift register when $\overline{\text{SYNC}}$ is low. If more than 18 clock pulses are applied, the data ripples out of the shift register and appears on the D_{OUT} line. This data is clocked out on the rising edge of SCLK and is valid on the falling edge. By connecting this line to the D_{IN} input on the next device in the chain, a multidevice interface is constructed. Eighteen clock pulses are required for each device in the system. Therefore, the total number of clock cycles must equal 18N, where N is the total number of devices in the chain. See the timing diagram in Figure 2.

When the serial transfer to all devices is complete, *SYNC* should be taken high. This prevents any further data being clocked into the input shift register. A burst clock containing the exact number of clock cycles may be used and *SYNC* taken high some time later. After the rising edge of *SYNC*, data is automatically transferred from each device's input shift register to the addressed DAC.

RESET Function

The *RESET* function on the AD5516 can be used to reset all nodes on this device to their power-on reset condition. This is implemented by applying a low going pulse of 20 ns minimum to the *RESET* Pin on the device.

BUSY Output

During conversion, the *BUSY* output is low and all SCLK pulses are ignored. At the end of a conversion, *BUSY* goes high indicating that the update of the addressed DAC is complete. It is recommended that SCLK is not pulsed while *BUSY* is low.

MICROPROCESSOR INTERFACING

The AD5516 is controlled via a versatile 3-wire serial interface that is compatible with a number of microprocessors and DSPs.

AD5516 to ADSP-2106x SHARC DSP Interface

The ADSP-2106x SHARC DSPs are easily interfaced to the AD5516 without the need for extra logic.

The AD5516 expects a t_3 ($\overline{\text{SYNC}}$ falling edge to SCLK falling edge setup time) of 15 ns min. Consult the *ADSP-2106x User Manual* for information on clock and frame sync frequencies for the SPORT Register and contents of the TDIV and RDIV Registers.

A data transfer is initiated by writing a word to the TX Register after the SPORT has been enabled. In write sequences, data is clocked out on each rising edge of the DSP's serial clock and clocked into the AD5516 on the falling edge of its SCLK. The SPORT transmit control register should be set up as follows:

Figure 6 shows the connection diagram.

***ADDITIONAL PINS OMITTED FOR CLARITY**

Figure 6. AD5516 to ADSP-2106x Interface

AD5516 to MC68HC11

The serial peripheral interface (SPI) on the MC68HC11 is configured for Master Mode (MSTR = 1), Clock Polarity Bit $(CPOL) = 0$, and the Clock Phase Bit $(CPHA) = 1$. The SPI is configured by writing to the SPI Control Register (SPCR)—see the *68HC11 User Manual*. SCK of the 68HC11 drives the SCLK of the AD5516, the MOSI output drives the serial data line (D_{IN}) of the AD5516. The $\overline{\text{SYNC}}$ signal is derived from a port line (PC7). When data is being transmitted to the AD5516, the *SYNC* line is taken low (PC7). Data appearing on the MOSI output is valid on the falling edge of SCK. Serial data from the 68HC11 is transmitted in 8-bit bytes with only eight falling clock edges occurring in the transmit cycle. Data is transmitted MSB first. In order to transmit 18 data bits, it is important to left justify the data in the SPDR Register. PC7 must be pulled low to start a transfer and taken high and low again before any further read/write cycles can take place. A connection diagram is shown in Figure 7.

Figure 7. AD5516 to MC68HC11 Interface

AD5516 to PIC16C6x/7x

The PIC16C6x/7x synchronous serial port (SSP) is configured as an SPI master with the Clock Polarity Bit $(CKP) = 0$. This is done by writing to the Synchronous Serial Port Control Register (SSPCON). See the *PIC16/17 Microcontroller User Manual*. In this example, I/O port RA1 is being used to provide a *SYNC* signal and enable the serial port of the AD5516. This microcontroller transfers only eight bits of data during each serial transfer operation; therefore, three consecutive write operations are required. Figure 8 shows the connection diagram.

Figure 8. AD5516 to PIC16C6x/7x Interface

AD5516 to 8051

A serial interface between the AD5516 and the 80C51/80L51 microcontroller is shown in Figure 9. The AD5516 requires a clock synchronized to the serial data. The 8051 serial interface must therefore be operated in Mode 0. TxD of the microcontroller drives the SCLK of the AD5516, while RxD drives the serial data line. P1.1 is a bit programmable pin on the serial port that is used to drive *SYNC*. The 80C51/80L51 provides the LSB first, while the AD5516 expects MSB of the 18-bit word first. Care should be taken to ensure the transmit routine takes this into account.

Figure 9. AD5516 to 8051 Interface

When data is to be transmitted to the DAC, P1.1 is taken low. Data on RxD is valid on the falling edge of TxD, so the clock must be inverted as the AD5516 clocks data into the input shift register on the rising edge of the serial clock. The 80C51/80L51 transmits its data in 8-bit bytes with only eight falling clock edges occurring in the transmit cycle. As the DAC requires an 18-bit word, P1.1 must be left low after the first eight bits are transferred and brought high after the complete 18 bits have been transferred. DOUT may be tied to RxD for data verification purposes when the device is in Daisy-Chain Mode.

APPLICATION CIRCUITS

The AD5516 is suited for use in many applications, such as level setting, optical, industrial systems, and automatic test applications. In level setting and servo applications where a fine-tune adjust is required, the Mode 2 function increases resolution. The following figures show the AD5516 used in some potential applications.

AD5516 in a Typical ATE System

The AD5516 is ideally suited for the level setting function in automatic test equipment. A number of DACs are required to control pin drivers, comparators, active loads, parametric measurement units, and signal timing. Figure 10 shows the AD5516 in such a system.

Figure 10. AD5516 in an ATE System

AD5516 in an Optical Network Control Loop

The AD5516 can be used in optical network control applications that require a large number of DACs to perform a control and measurement function. In the example shown in Figure 11, the outputs of the AD5516 are fed into amplifiers and used to control actuators that determine the position of MEMS mirrors in an optical switch. The exact position of each mirror is measured and the readings are multiplexed into an 8-channel, 14-bit ADC (AD7865). The increment and decrement modes of the DACs are useful in this application as they allow 14-bit resolution.

The control loop is driven by an ADSP-2106x, a 32-bit SHARC® DSP.

Figure 11. AD5516 in an Optical Control Loop

AD5516 in a High Current Circuit

Access to the feedback loop of the AD5516 amplifier provides greater flexibility, e.g., it enables the user to configure the device as a digitally programmable current source or increase the output drive current. See Figure 12. Note that V_{DD} must be chosen

so that the DAC output has enough headroom to drive the $BIT \sim 0.7$ V above the maximum output voltage.

Figure 12. AD5516 in a High Current Circuit

Note it is not intended that the R_{FB} nodes be used to alter amplifier gain or for force/sense in remote sense applications.

POWER SUPPLY DECOUPLING

In any circuit where accuracy is important, careful consideration of the power supply and ground return layout helps to ensure the rated performance. The printed circuit board on which the AD5516 is mounted should be designed so that the analog and digital sections are separated and confined to certain areas of the board. If the AD5516 is in a system where multiple devices require an AGND-to-DGND connection, the connection should be made at one point only. The star ground point should be established as close as possible to the device. For supplies with multiple pins $(AV_{CC}1, AV_{CC}2)$, it is recommended to tie those pins together. The AD5516 should have ample supply bypassing of 10μ F in parallel with 0.1μ F on each supply located as closely to the package as possible, ideally right up against the device. The 10 μ F capacitors are the tantalum bead type. The 0.1μ F capacitor should have low effective series resistance (ESR) and effective series inductance (ESI), like the common ceramic types that provide a low impedance path to ground at high frequencies, to handle transient currents due to internal logic switching.

The power supply lines of the AD5516 should use as large a trace as possible to provide low impedance paths and reduce the effects of glitches on the power supply line. Fast switching signals such as clocks should be shielded with digital ground to avoid radiating noise to other parts of the board, and should never be run near the reference inputs. A ground line routed between the D_{IN} and SCLK lines will help reduce crosstalk between them (not required on a multilayer board as there will be a separate ground plane, but separating the lines will help). It is essential to minimize noise on REFIN.

Avoid crossover of digital and analog signals. Traces on opposite sides of the board should run at right angles to each other. This reduces the effects of feedthrough through the board. A microstrip technique is by far the best, but not always possible with a double-sided board. In this technique, the component side of the board is dedicated to ground plane while signal traces are placed on the solder side.

As is the case for all thin packages, care must be taken to avoid flexing the package and to avoid a point load on the surface of the package during the assembly process.

OUTLINE DIMENSIONS

74-Lead Chip Scale Ball Grid Array [CSPBGA]

(BC-74)

Dimensions shown in millimeters

COMPLIANT TO JEDEC STANDARDS MO-192ABD-1

Revision History

 $CO2792 - 0 - 8/03(B)$ C02792–0–8/03(B)

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